IPC ASSOCIATION CONNEC	Material Compo © Copyright 2005. IPo international and Pan-	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information				
upplier Info	rmation				·										
Company name* Company uniqu				ique ID U			Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact Name			Title - Contact			Phone - C	Phone - Contact*					Email - Contact*			
Product-Env-Ste	ewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*		Title - Representative			Phone - F	Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Environment				viro Compliance		NA	NA				Product-Env-Stewards@onsemi.com				
Reque	Requester Item Number Mfr Iter		m Number Mfr Item Name			Effective	Date	Version Manufacturing Site		W	eight*	UOM	Unit Type		
		CAT24S	CAT24S128C4UTR 128KB I2C CMOS Serial EE Software Write Protect in thir			2023-06-	-08		С	CNQ		349085	mg	Each	
Ianufacturin	ng Proccess Informati	ion										1			
Terminal Plating / Grid Array Material Ter			erminal Base Alloy J-STD-020 MSL I		-STD-020 MSL Rating	Peal	Peak Process Body Temperature Ma		e Max Time at Peak	Temperatu	re Numb	er of Reflow Cyc	eles		
SnAgCu CU			U Alloy 1			260	260   C   30		seconds 3						
omments															
vel 1 - maximur	n time at peak temperatur	e during sol	dering is 10-3	30 seconds											
or more inform	ation regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and corrections that such information is true and corrections that such information is true and corrections. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not or written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the w											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film	0.025709	mg		Epoxy resin	proprietary data		0.0054	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0005	mg
			Supplier	Acrylic resins	Proprietary Data		0.0054	mg
			Supplier	Silica (SiO2)	14464-46-1		0.0145	mg
Die	0.243332	mg	Supplier	Silicon (Si)	7440-21-3		0.2433	mg
Insulating Layer	0.010392	mg		Polyimide	proprietary data		0.0104	mg
RDL	0.010392	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0103	mg
Solder Ball	0.052281		Supplier	Silver (Ag)	7440-22-4		0.0014	mg
			Supplier	Tin (Sn)	7440-31-5		0.0506	mg
			Supplier	Copper (Cu)	7440-50-8		0.0003	mg
Under Bump Metal	0.006979	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0069	mg